

VS6522AD-VB Datasheet P-Channel 60 V (D-S) MOSFET

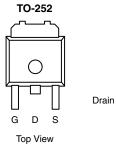
PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^d	Q _g (Typ)		
- 60	0.046 at V _{GS} = - 10 V	- 35	26		
- 00	0.058 at V _{GS} = - 4.5 V	- 30	20		

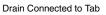
FEATURES

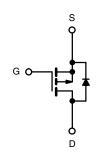
- Halogen-free According to IEC 61249-2-21
 Definition
- Trench Power MOSFET
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- High Side Switch for Full Bridge Converter
- DC/DC Converter for LCD Display







P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_A =$	= 25 °C, unless otherw	vise note)			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	- 60	v	
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current (T_{I} = 150 °C)	T _C = 25 °C	I _D	- 35		
Continuous Drain Current (1j = 150°C)	T _C = 125 °C	D	- 25	А	
Pulsed Drain Current		I _{DM}	- 100		
Avalanche Current, Single Pulse		I _{AS}	- 22	7	
Repetitive Avalanche Energy, Single Pulse ^a L = 0.1 mH		E _{AS}	24.2	mJ	
Power Dissinction	T _C = 25 °C	Pn	38.5 ^c	w	
Power Dissipation	T _A = 25 °C		2.3 ^{b, c}	V	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Marine harding to Anthiastb	t ≤ 10 s	R _{thJA}	17	21	°C/W	
Maximum Junction-to-Ambient ^b	Steady State		45	55		
Maximum Junction-to-Case		R _{thJC}	2.7	3.25		
Notes:						

a. Duty cycle \leq 1 %.

b. When mounted on 1" square PCB (FR-4 material).

c. See SOA curve for voltage derating.

d. Based up on $T_C = 25 \ ^{\circ}C$.

HALOGEN

Available



Parameter	Symbol	Test Conditions	Min .	Тур.	Max.	Unit	
Static	<u>.</u>						
Drain-Source Breakdown Voltage	V _{DS}	V_{GS} = 0 V, I _D = - 250 μ A	- 60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 1		- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			- 50	μA	
		V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 150 $^{\circ}$ C	- 125		- 125		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 V, V_{GS} = -10 V$	- 20			А	
		V _{GS} = - 10 V, I _D = - 10 A	0.046				
Drain-Source On-State Resistance ^a	Broken	V_{GS} = - 10 V, I _D = - 10 A, T _J = 125 °C		0.095		Ω	
Dialit-Source Off-State Resistance	R _{DS(on)}	V_{GS} = - 10 V, I _D = - 10 A, T _J = 150 °C	0.115				
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -5 \text{ A}$					
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 10 A		22		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1900		pF	
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = - 25 V, f = 1 MHz		130			
Reverse Transfer Capacitance	C _{rss}			90			
Total Gate Charge ^c	Qg			26	40	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -30$ V, $V_{GS} = -10$ V, $I_{D} = -10$ A		4.5			
Gate-Drain Charge ^c	Q _{gd}			7		1	
Gate Resistance	Rg	f = 1 MHz		7		Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	15		
Rise Time ^c	t _r	V_{DD} = - 30 V, R_L = 3 Ω		9	15		
Turn-Off Delay Time ^c	t _{d(off)}	$\rm I_D \cong$ - 19 A, $\rm V_{GEN}$ = - 10 V, $\rm R_g$ = 2.5 Ω		65	100	ns	
Fall Time ^c	t _f	1		30	45		
Drain-Source Body Diode and Charact	eristics (T _C = 2	5 °C) ^b					
Continuous Current	I _S				- 20		
Pulsed Current	I _{SM}				- 30	A	
Forward Voltage ^a	V _{SD}	I _F = - 19 A, V _{GS} = 0 V		- 1	- 1.5	V	
Reverse Recovery Time	t _{rr}	I _F = - 19 A, di/dt = 100 A/μs		41	61	ns	

Notes:

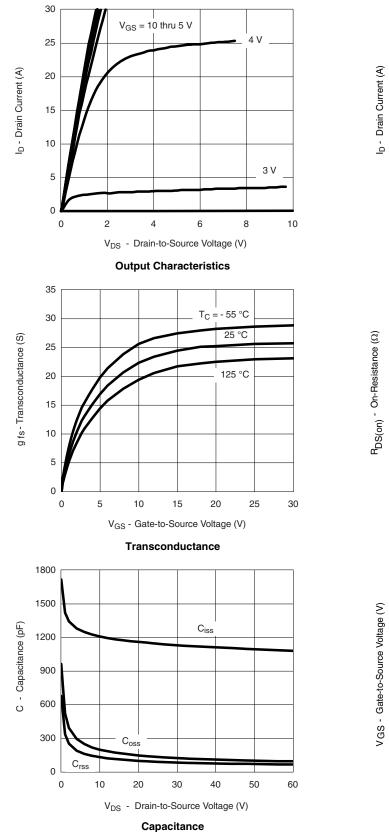
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

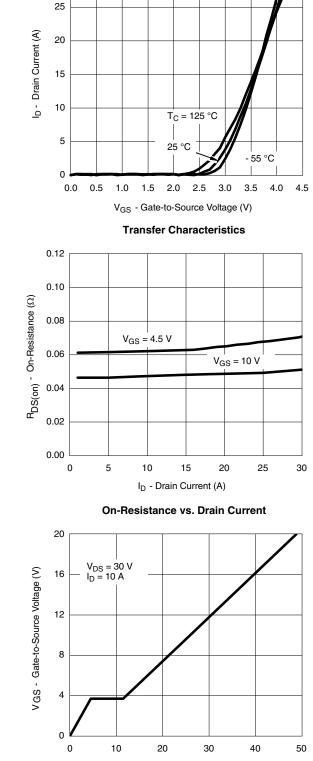
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

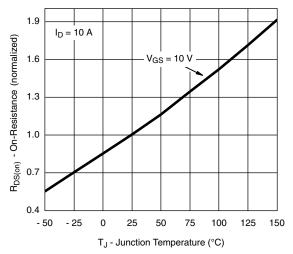


Qg - Total Gate Charge (nC)

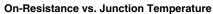
Gate Charge

30

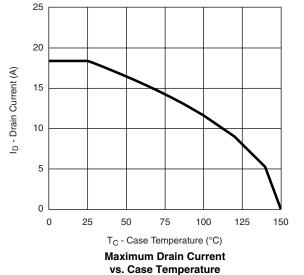


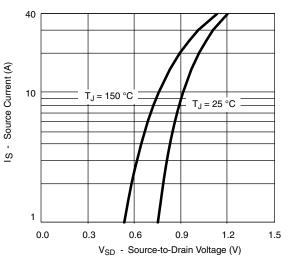


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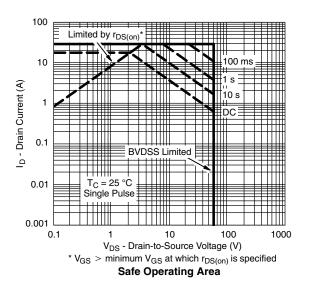


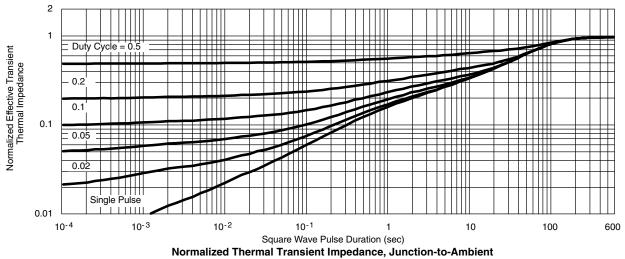






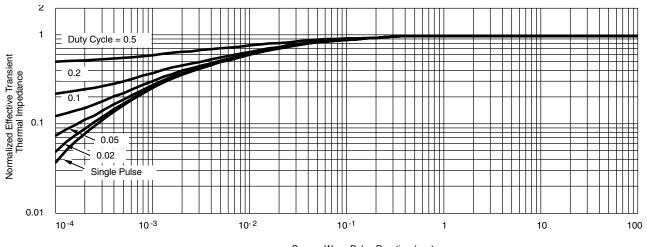
Source-Drain Diode Forward Voltage







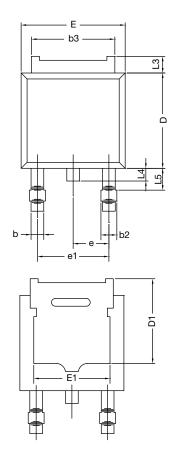
THERMAL RATINGS



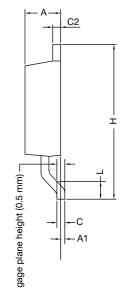
Square Wave Pulse Duration (sec)

Normalized Thermal Transient Impedance, Junction-to-Case





TO-252AA Case Outline



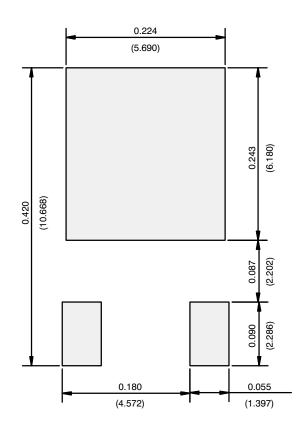
	MILLIN	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090 BSC		
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16-0236-Rev. P, 16-May-16 DWG: 5347					

Notes

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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